



Schematic Key for Multilayer and HDI-Technology Build-Ups

a	b	c	d	e	f	g + h + i
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08 208 FR4 35 L20.35 L36.35 P10_06

columns and equal kind of positions are separated by "_". Equal prefixes in one column are reduced to one.

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Layers	in μ	Material	Build-Up	Assembly		
Layer-1	35 μ	Copper				
	60 μ	Prepreg			(60 μ PrePreg-Type: 1080)	
	100 μ	Prepreg			(100 μ PrePreg-Type: 2125)	
	100 μ	Prepreg				
Layer-2	35 μ	Copper			A1	
	200 μ	L-FR4				
Layer-3	35 μ	Copper			B	
	60 μ	Prepreg				
	100 μ	Prepreg				
	100 μ	Prepreg				
Layer-4	35 μ	Copper		A2		
	360 μ	L-FR4				
Layer-5	35 μ	Copper		B		
	100 μ	Prepreg				
	100 μ	Prepreg				
	60 μ	Prepreg				
Layer-6	35 μ	Copper			A3	
	200 μ	L-FR4				
Layer-7	35 μ	Copper			B	
	100 μ	Prepreg				
	100 μ	Prepreg				
	60 μ	Prepreg				
Layer-99	35 μ	Copper				